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N-Channel PowerTrench[®] MOSFET 30 V, 15 A, 19 m Ω

Features

- Max $r_{DS(on)}$ = 19 m Ω at V_{GS} = 10 V, I_D = 9.0 A
- Max $r_{DS(on)}$ = 30 m Ω at V_{GS} = 4.5 V, I_D = 7.2 A
- High performance technology for extremely low r_{DS(on)}
- Termination is Lead-free and RoHS Compliant

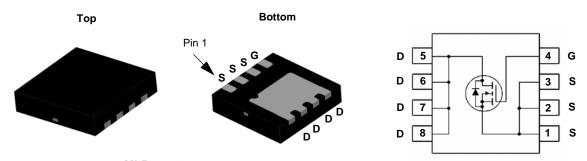


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

Application

- High side in DC DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



MLP 3.3x3.3

MOSFET Maximum Ratings $T_A = 25 \ ^{\circ}C$ unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		15		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	9.0	Α	
	-Pulsed			40		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	24	mJ	
P _D	Power Dissipation	T _C = 25 °C		18	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

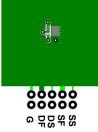
Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	6.6	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	53	C/vv

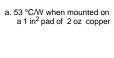
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC8884	FDMC8884	MLP 3.3x3.3	13 "	12 mm	3000 units

	Parameter Test Conditions		Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	30			V
ΔBV _{DSS} ΔT」	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		22		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V T _J = 125 °C			1 250	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.4	1.9	2.5	V
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-6		mV/°C
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 9.0 A		16	19	
r _{DS(on)}		$V_{GS} = 4.5 \text{ V}, \ I_D = 7.2 \text{ A}$		22	30	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 9.0 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		22	30	30
9 _{FS}	Forward Transconductance	$V_{DD} = 5 \text{ V}, \ I_D = 9.0 \text{ A}$		24		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			513	685	pF
C _{oss}	Output Capacitance	── V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		110	150	pF
C _{rss}	Reverse Transfer Capacitance			76	115	pF
R _g	Gate Resistance			1.4	2.1	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			6	12	ns
t _r	Rise Time	V _{DD} = 15 V, I _D = 9.0 A,		2	10	ns
1	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		15	27	ns
d(off)						
	Fall Time			2	10	ns
t _f	Fall Time Total Gate Charge	V _{GS} = 0 V to 10 V		2 10	10 14	ns nC
t _f		V _{GS} = 0 V to 10 V				
Q _{g(TOT)}	Total Gate Charge			10	14	nC
α _{g(TOT)}	Total Gate Charge Total Gate Charge	V _{GS} = 0 V to 10 V		10 5.0	14	nC nC
t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd} Drain-Sou	Total Gate Charge Total Gate Charge Total Gate Charge	V _{GS} = 0 V to 10 V		10 5.0 1.8	14	nC nC nC
t _f Q _{g(TOT)} Q _{gs} Q _{gd} Drain-Sou	Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{GS} = 0 V \text{ to } 10 V$ $V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 15 V$ $I_{D} = 9.0 \text{ A}$		10 5.0 1.8	14	nC nC nC
t _f Q _{g(TOT)} Q _{gs} Q _{gd}	Total Gate ChargeTotal Gate ChargeTotal Gate ChargeGate to Drain "Miller" Charge	$V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V}$ $I_{D} = 9.0 \text{ A}$		10 5.0 1.8 2.2	14 7.0	nC nC nC
t _f Q _{g(TOT)} Q _{gs} Q _{gd} Drain-Sou	Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{GS} = 0 \ V \ to \ 10 \ V$ $V_{GS} = 0 \ V \ to \ 4.5 \ V$ $I_D = 15 \ V$ $I_D = 9.0 \ A$ $V_{GS} = 0 \ V, \ I_S = 9.0 \ A \qquad (Note \ 2)$		10 5.0 1.8 2.2 0.86	14 7.0 1.2	nC nC nC



2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.



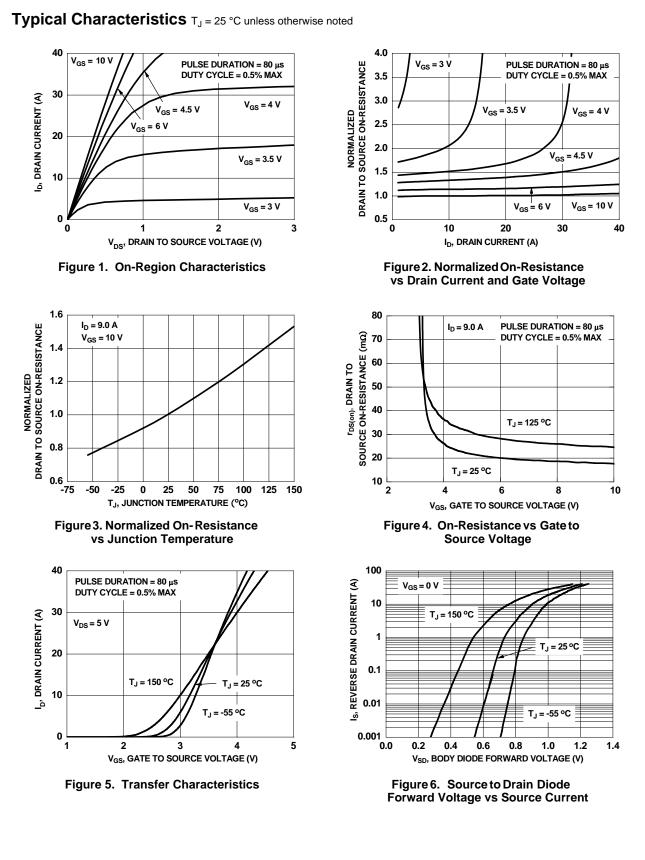
3. E_{AS} of 24 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 7 A, V_{DD} = 30 V, V_{GS} = 10 V. 100% test at L = 3 mH, I_{AS} = 4 A .



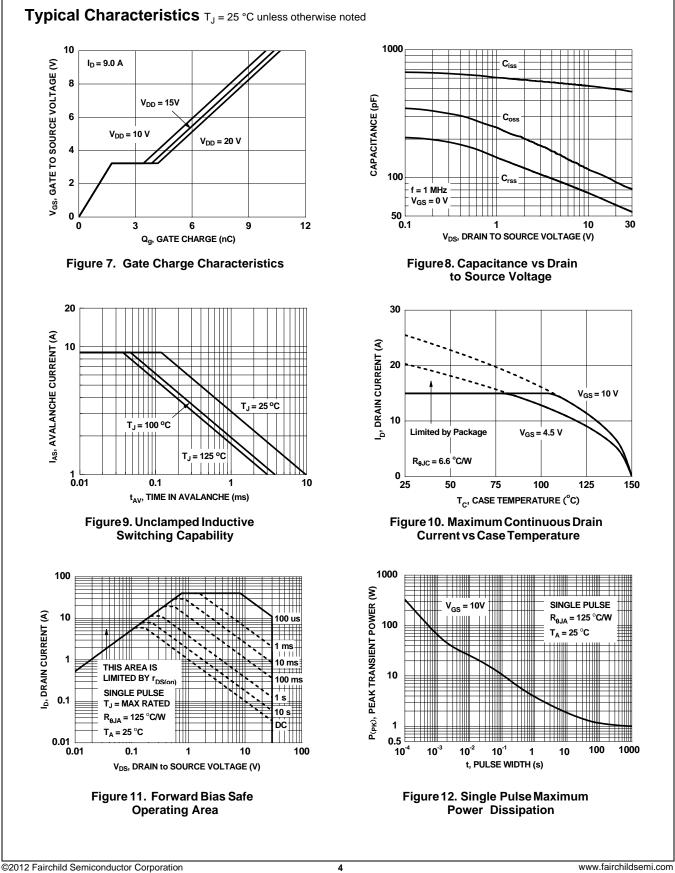
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FDMC8884 N-Channel PowerTrench[®] MOSFET

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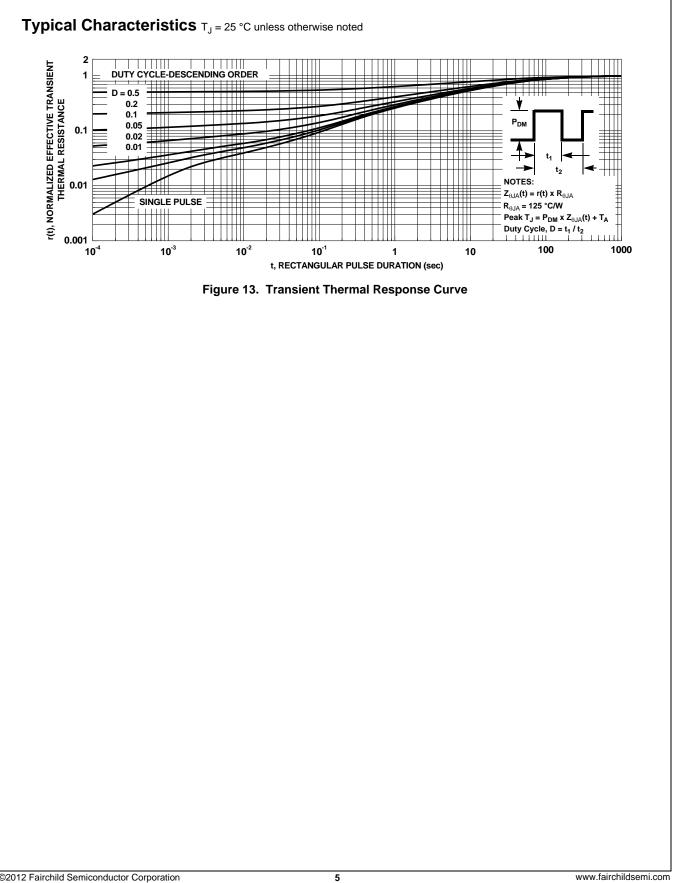


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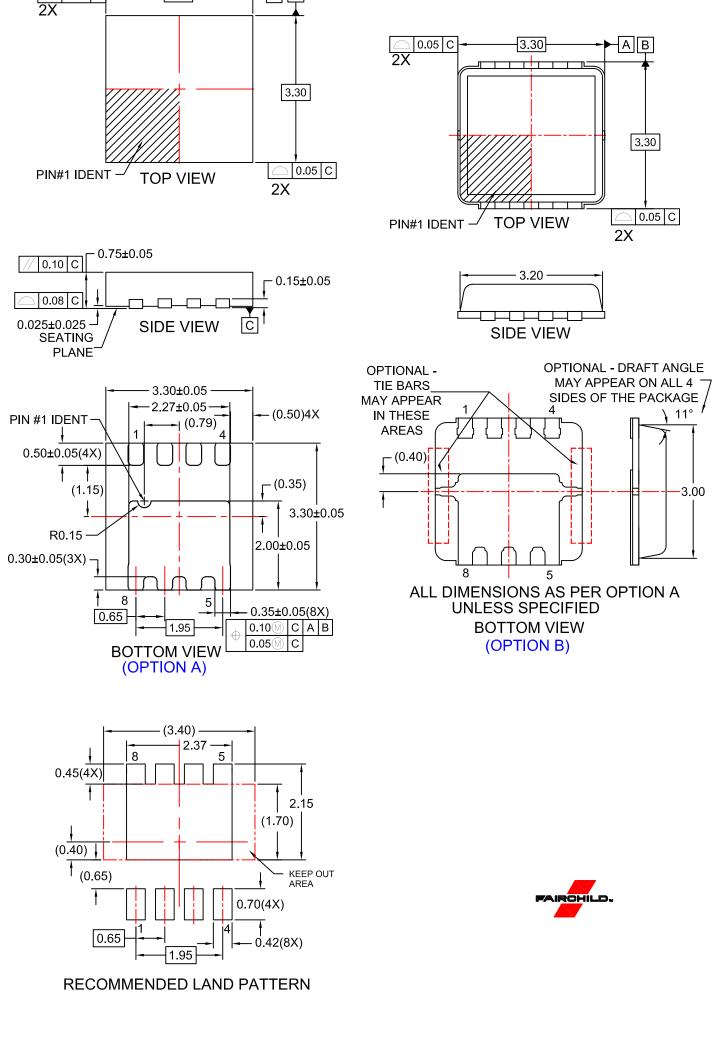


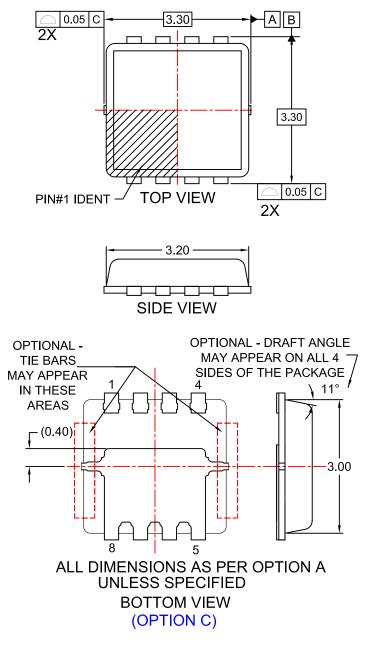
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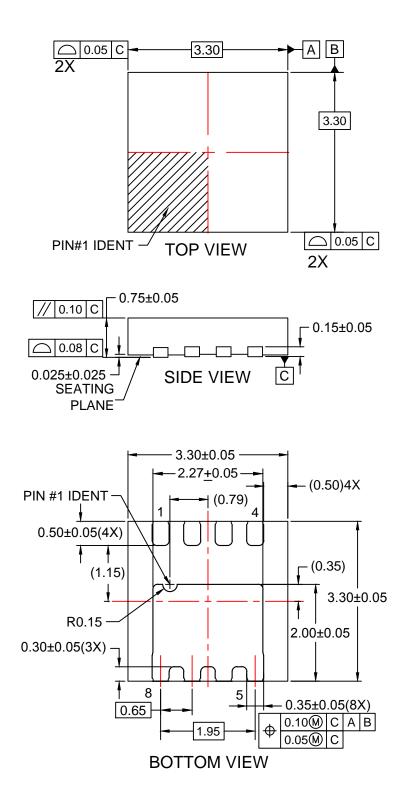


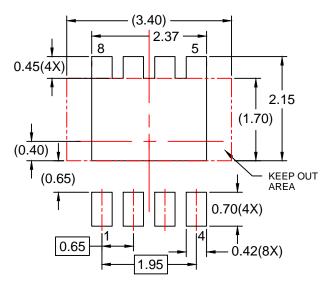


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